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/!\ REMINDERS

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- Please contact Taiyo Yuden Co., Ltd. for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of products in actual condition of mounting and operating environment before commercial shipment of the equipment.
- All electronic components or functional modules listed in this catalog are developed, designed and intended for use in general electronics equipment. (for AV, office automation, household, office supply, information service, telecommunications, (such as mobile phone or PC) etc.). Before incorporating the components or devices into any equipment in the field such as transportation, (automotive control, train control, ship control), transportation signal, disaster prevention, medical, public information network (telephone exchange, base station) etc. which may have direct influence to harm or injure a human body, please contact Taiyo Yuden Co., Ltd. for more detail in advance.

Do not incorporate the products into any equipment in fields such as aerospace, aviation, nuclear control, submarine system, military, etc. where higher safety and reliability are especially required.

In addition, even electronic components or functional modules that are used for the general electronic equipment, if the equipment or the electric circuit require high safety or reliability function or performances, a sufficient reliability evaluation check for safety shall be performed before commercial shipment and moreover, due consideration to install a protective circuit is strongly recommended at customer's design stage.

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積層チップNTCサーミスタ **MULTILAYER CHIP NTC THERMISTORS**

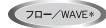
OPERATING TEMP.

-55~+125°C











- *1005TYPEを除く
- *Except for 1005TYPE

特長 FEATURES

- ・125℃保証
- ・B定数が大きく温度検知能力が優れている
- ・表裏の区別がなくバルク、テーピングでの自動装着が可能
- ・寸法はEIAJ規格に準拠
- ・内部電極構造を採用することにより、信頼性向上を実現しています
- Guaranteed up to 125℃.
- · Large B constant for higher temperature sensing capability.
- · Ideal for automatic mounting in bulk or from tapes because of front-rear
- · Available in a standard EIA compatible case size.
- · Improved reliability due to use of internal electrodes.

APPLICATIONS

- 通信機用
- 自動車電話、携帯電話、コードレス電話ほか ・OA機器用
- プリンタ.
- ファクシミリ、ワードプロセッサほか
- ・民生機器用
- ビデオ、カラーテレビ、液晶テレビ、CDプレーヤほか
- ・バッテリ保護回路用

- · Telecommunications equipment: mobile telephones, cellular telephones, cordless telephones, etc.
- · Office automation: printers, facsimiles, word processors, etc.
- · Consumer electronics: VCRs, color television sets, LCD television sets, CD players, etc.
- · Battery protection circuit

形名表記法 ORDERING CODE



形式 NTCサーミスタ ТВ



形状 メッキ電極品 Р

寸法 [mm]	
S0	1.0×0.5 (0402)
S1	1.6×0.8 (0603)

包装	
R	紙テーピング
0	畄旦 (伐づめ)

5

公称零負荷抵抗[Ω]		負荷抵抗 [Ω]
	例	
	102	1000
	154	150000

6

抵抗許容差[%]	
F	± 1
G	± 2
Н	± 3
J	± 5
K	±10

公称B定数 [K]		
例	記号×10	
295	2950	
410	4100	

8

B定数	許容差 [%]
F	±1
Н	±3

最低温度[℃]		
5	-55	

1

最高温	l度 [℃]	
Q	125	

•		
当社管	理記号	
\triangle		標準品
		△=スペース

T, B, P, S, 1, S, 1, 0, 3, K, 4, 4, 0,



Туре NTC THERMISTOR TB



Dimension [mm] 1.0×0.5 (0402) S0 S1

Packaging R Tape&Reel S Bulk

Nominal Zero-Power Resistance [0]

Troffilliai Zelo i owei i lesistarioc [32]	
example	
102	1000
154	150000

6

Resistance tolerance [%]	
F	± 1
G	± 2
Н	± 3
J	± 5
K	±10

Nominal B constant [K]	
example	Symbol×10
295	2950
410	4100

8

B cons	B constant tolerance[%]					
F	±1					
H ±3						

Min. temperature [°C]

Max. temperature [°C]

D

Internal code Standard product △=Blank space

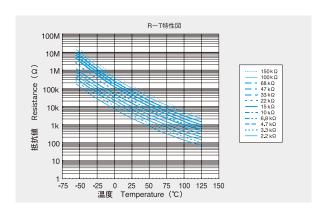
Type	L	W	T	е
1005 (0.100)	1.0±0.05	0.5 ± 0.05	0.5±0.05	0.25±0.10
1005 (0402)	(0.039±0.002)	(0.020 ± 0.002)	(0.020 ± 0.002)	(0.010 ± 0.004)
1000 (0000)	1.6±0.15	0.8±0.15	0.8±0.15	0.35±0.25
1608 (0603)	(0.063±0.006)	(0.031 ± 0.006)	(0.031 ± 0.006)	(0.014±0.010)

Unit: mm (Inch)

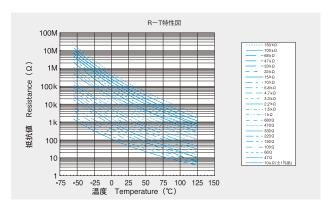
9 THERMISTORS

R-T特性図 **R-T CHARACTERISTICS**

1005type (0402)



1608type (0603)



仕様 **SPECIFICATIONS**

	許容差 (記号) Tolerance (Symbols)				
R25	$\pm 1\%$ (F), $\pm 2\%$ (G), $\pm 3\%$ (H), $\pm 5\%$ (J), $\pm 10\%$ (K)				
B定数	140((5) 100((11)				
B Constant	±1%(F), ±3% (H)				

セレクションガイド Selection Guide **⋖** P.16

アイテム一覧 Part Numbers P.474 特性図 Electrical Characteristics P.475



信頼性 Reliability Data P.478



1005TYPE -

形 名 Ordering Code	EHS (Environmental Hazardous	R25 [kΩ]		E数 nstant	熱時定数 Thermal time	熱放散定数 Dissipation	定格電力 Rated Power	備 考 Remark
-	Substances)		(K: 25/85°C)	(K: 25/50°C)	constant	factor		
TBPS0○222△410H5Q	RoHS	2.2	4100	4034				
TBPS0○332△410H5Q	RoHS	3.3	4100	4034				
TBPS0○472△410H5Q	RoHS	4.7	4100	4034				
TBPS0○682△410H5Q	RoHS	6.8	4100	4034				
TBPS0○103△410H5Q	RoHS	10	4100	4034				
TBPS0○153△410H5Q	RoHS	15	4100	4034	≦3 sec	0.5~2.0	35mW	
TBPS0○223△440H5Q	RoHS	22	4400	4336		mW/°C		
TBPS0○333△455H5Q	RoHS	33	4550	4483				
TBPS0○473△455H5Q	RoHS	47	4550	4483				
TBPS0○683△455H5Q	RoHS	68	4550	4483				
TBPS0○104△455H5Q	RoHS	100	4550	4483				
TBPS0○154△455H5Q	RoHS	150	4550	4483				

形名の \bigcirc には包装 (R=テーピング、S=単品)、 \triangle には抵抗許容差記号 (J,K) が入ります。

 \bigcirc Please specify the packaging code (R : tape & reel, S : Bulk) and \triangle the resistance tolerance code (J, K).

1608TYPE -

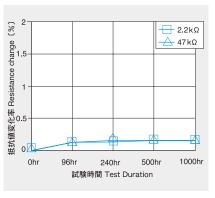
形 名 Ordering Code	EHS B定数 Hazardous [κΩ]			熱時定数 熱放散定数 Thermal time Dissipation	定格電力 Rated Power	備 考 Remark		
	Substances)		(K: 25/85°C)	(K: 25/50°C)	constant	factor		
TBPS1○470△295H5Q	RoHS	0.047	2950	2934				
TBPS1○680△295H5Q	RoHS	0.068	2950	2934				
TBPS1○101△315H5Q	RoHS	0.100	3150	3157				
TBPS1○151△315H5Q	RoHS	0.150	3150	3157				
TBPS1○221△410H5Q	RoHS	0.22	4100	4034				
TBPS1○331△410H5Q	RoHS	0.33	4100	4034				
TBPS1○471△410H5Q	RoHS	0.47	4100	4034				
TBPS1○681△410H5Q	RoHS	0.68	4100	4034				
TBPS1○102△410H5Q	RoHS	1.0	4100	4034				
TBPS1○152△410H5Q	RoHS	1.5	4100	4034				
TBPS1○222△410H5Q	RoHS	2.2	4100	4034		1.0~2.5		
TBPS1○332△410H5Q	RoHS	3.3	4100	4034	≦5 sec	mW/°C	63mW	
TBPS1○472△440H5Q	RoHS	4.7	4400	4336				
TBPS1○682△440H5Q	RoHS	6.8	4400	4336				
TBPS1○103△440H5Q	RoHS	10	4400	4336				
TBPS1○153△460H5Q	RoHS	15	4600	4533				
TBPS1○223△460H5Q	RoHS	22	4600	4533	1			
TBPS1○333△460H5Q	RoHS	33	4600	4533	1			
TBPS1○473△475H5Q	RoHS	47	4750	4642	1			
TBPS1○683△475H5Q	RoHS	68	4750	4642	1			
TBPS1○104△475H5Q	RoHS	100	4750	4642	1			
TBPS1○154△475H5Q	RoHS	150	4750	4642				
TBPS1○103△344F5Q	RoHS	10	3435	3395	1			

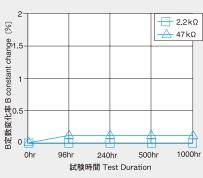
形名の○には包装 (R=テーピング、S=単品)、△には抵抗値許容差記号 (J, K (TBP S1 ○ 103 △ 344 F 5QはF,GまたはH)) が入ります。

Please specify the packaging code (R : tape & reel, S : Bulk) and △ the resistance tolerance code (F,G or H for TBP S1 ◯ 103 △ 344 F 5Q J, K for other part numbers).

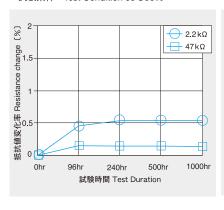
1005type (0402)

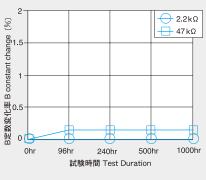
高温放置 High Temperature Life Test -試験条件 Test Condition 125℃





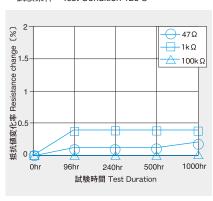
耐湿性 Damp Heat (steady state) · 試験条件 Test Condition 85℃95%

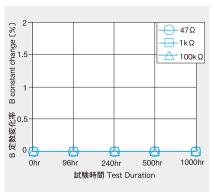




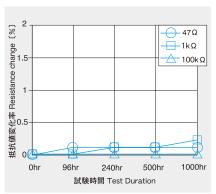
1608type (0603)

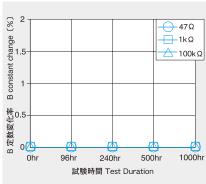
高温放置 High Temperature Life Test 試験条件 Test Condition 125℃





耐湿性 Damp Heat (steady state) 試験条件 Test Condition 85℃95%



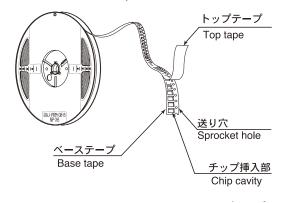


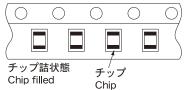
①最小受注単位数 Minimum Quantity

形式	製品厚み	標準数量 Standar	rd quantity [pcs]
Type	Thickness [mm]	袋づめ Bulk	紙テープ Taping
1005 (0402)	0.5 (0.020)	10000	10000
1608 (0603)	0.8 (0.031)	2000	4000

②テーピング材質 Tape material

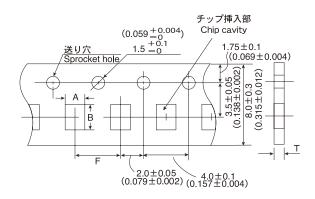
紙テープ Card board carrier tape





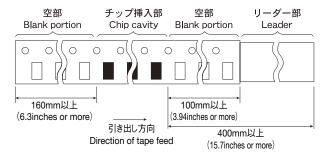
③テーピング寸法 Taping Dimensions

紙テープ (8mm幅) Paper tape (0.315inches wide)

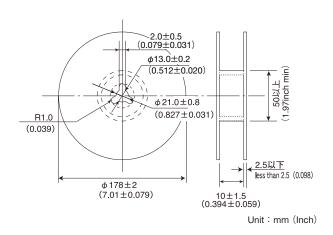


TL -12	チップ	挿入部	挿入ピッチ	テープ厚み
形 式 Type	Chip	cavity	Insertion pitch	Tape thickness
71	A	В	F	T
1005 (0402)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
1005 (0402)	(0.026±0.004)	(0.045±0.004)	(0.079±0.002)	(0.031max)
1608 (0603)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
1608 (0603)	(0.039±0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
			Unit	: mm (Inch)

④リーダー部・空部 Leader and Blank portion

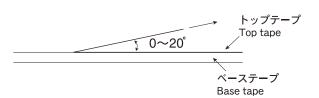


⑤リール寸法 Reel size



⑥トップテープ強度 Top Tape Strength

トップテープのはがし力は下図矢印方向にて0.1~0.7Nとなります。 The top tape requires a peel;-off force of $0.1 \sim 0.7 N$ in the direction of the arrow as illustrated below.



MULTILAYER CHIP NTC THERMISTORS

MULTILAYER CHIP NTC THERMISTO	PRS				
ltem	Specifie	ed Value	Test Methods and Remarks		
	1005 (0402)	1608 (0603)			
Operating Temperature Range	-55 to	+125°C			
2. Storage Temperature Range	-55 to	+125℃			
3. Rated Power	35mW	63mW			
4. Nominal Zero-Power Resistance	2.2~150kΩ	0.047~150kΩ	Ambient temperature: 25±0.2°C		
	±5% ±10%	±5% ±10%	Measuring electric power: 0.1mW max.		
5. Nominal B Constant	4100~4550K	2950∼4750K	Measure the resistance at the ambient temperatures of 25±0.2°C and +85±0.2°C.		
J. Normal D Constant	±3%	±3%	$B = \frac{\ln R25 - \ln R85}{1 / T25 - 1 / T85}$ $T : Absolute temperature$ $T0 : 273.15$		
6. Dissipation Constant (single unit)	0.5 to 2.0mW / °C	1.0 to 2.5mW / °C	This represents the amount of electric power required to raise the temperature of the element by 1°C through self-heating under thermal equilibrium.		
7. Thermal Time Constant (single unit)	Within 3 sec.	Within 5 sec.	This represents the amount of time for the temperature of the thermistor element to change by 63.2% of the difference between the initial temperature and the ambient temperature by the drastic change of power application into thermistor from non-zero-power to zero-power state.		
8. Rated Ambient Temperature	25	S°C	This represents the maximum ambient temperature at which rated power could be applied.		
			mum permissible power. Strong 100 Law		
10. Resistance to Flexure of Substrate	R25 change : Within ±3% B constant change : Within ±1%	R25 change : Within ±5% B constant change : Within ±2%	Warp : 2mm Testing board : glass-epoxy-resin substrate Board thickness : 0.8mm Pressing speed : 0.5mm/sec. Duration : 30 sec. PCB R-230 Warp Warp Unit : mm]		
11. Adhesion of Terminal Electrode	R25 change : Within $\pm 3\%$ B constant change : Within $\pm 1\%$	R25 change : Within ±5% B constant change : Within ±2%	Applied force: 5N Duration: 10sec. Hooked Jig Cross section		

MULTILAYER CHIP NTC THERMISTORS

ltem	Specified Value		Test Methods and Remarks
	1005 (0402)	1608 (0603)	
12. Solderability	At least 75% of terminal	At least 80% of terminal	According to JIS C5102 clause 8.4.
	electrode is covered by new	electrode is covered by new	Solder temperature : 230±5°C
	solder.	solder.	Duration : 4±1 sec.
13. Resistance to Soldering	R25 change: Within ±3%	R25 change : Within ±5%	Reflow soldering:
	B constant change :	B constant change :	Solder temperature: 240°C
	Within ±1%	Within ±2%	Duration: 5 sec.
			Preheating temperature: 150°C
			Preheating time : 90 sec.
			Number of reflows: 3 times
			testing substrate : glass-epoxy-resin substrate
14. Thermal Shock	R25 change : Within ±3%	R25 change : Within ±5%	Conditions for 1 cycle
	B Constant change :	B Constant change :	Step1 : Minimum operating temperature +0 ∕ −3°C 30±3 min
	Within ±1%	Within ±3%	Step2 : Room temperature 2 to 3 min
			Step3 : Maximum operating temperature +0 ∕ −3°C 30±3 min
			Step4 : Room temperature 2 to 3 min
			Number of cycles : 5
			Recovery: 2 to 3 hrs of recovery under the standard condition after the test.
15. High Temperature Life Test	R25 change: Within ±3%	R25 change: Within ±5%	Temperature: 125±2°C
3 1 1	B Constant change :	B Constant change :	Duration: 1000±12 hrs
	Within ±1%	Within ±3%	Recovery: 2 hrs of recovery under the standard condition after the removal from test chamber.
			testing substrate : glass-epoxy-resin substrate
16. Damp Heat (steady state)	R25 change : Within ±3%	R25 change: Within ±5%	Temperature: 85±2°C
•	B Constant change :	B Constant change :	Humidity: 85±5%RH
	Within ±1%	Within ±3%	Duration: 1000±12 hrs
			Recovery : 2 hrs of recovery under the standard condition after the removal from test chamber.
			testing substrate: glass-epoxy-resin substrate

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to $35^{\circ}\!C$ of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

When there are questions concerning measurement results :

In order to provide correlation data, the test shall be conducted under condition of 20 ± 2°C of temperature, 60 to 70% relative humidity and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."